

XENSIV™ PAS CO2 mini-board description and application hints

About this document

This application note should enable the user to integrate the XENSIV™ PAS CO2 mini-board into a system.

Scope and purpose

This application note will give a complete overview of the XENSIV™ PAS CO2 mini-board.

Intended audience

Application engineers, system engineers and system architects of an application where the XENSIV™ PAS CO2 mini-board will be integrated.

Order information

SP005577475

Table of contents

| | |
|--|----------|
| About this document | 1 |
| Table of contents | 1 |
| 1 Introduction to XENSIV™ PAS CO2 mini-board | 2 |
| 2 Example connection with the PSoC® 6 WiFi-BT Pioneer Kit | 4 |
| Revision history | 5 |

XENSIV™ PAS CO2 mini-board

description and application hints

1 Introduction to XENSIV™ PAS CO2 mini-board

The XENSIV™ PAS CO2 is a real CO₂ sensor that improves on the size and performance of existing CO₂ sensor solutions. The sensor's high accuracy level makes it the right choice for indoor air-quality monitoring stations, HVAC systems and IoT applications. To ensure successful evaluation of the sensor, multiple evaluation platforms are offered. Among them, the XENSIV™ PAS CO2 Sensor2Go kit has been covered in a separate application note. The second evaluation platform is called the XENSIV™ PAS CO2 mini-board, which is covered in this application note.

The XENSIV™ PAS CO2 mini-board comes with the following features:

- Easy connection to the application board with a standard 2.54 mm pin header. There is no need to go through a reflow process during the evaluation phase.
- Access to all signals and functions of the product.
- Compatible with a combined PCB layout, supporting reflow assembly for later use.
- Compatible with XENSIV™ PAS CO2 Sensor2Go kit for easy lab evaluation.

We encourage use of the combi-layout feature to evaluate the application fit of the sensor. The footprint of the original PAS should already be envisioned during the design-in phase. The evaluation can be carried out with the mini-board and, after primary evaluation, the XENSIV™ PAS CO2 can be used directly for the final product. The example combi-layout is shown in Figure 1. The reference Altium file can be downloaded from the download section of the product page.

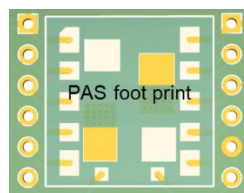


Figure 1 Example combi-layout of XENSIV™ PAS CO2 mini-board

The XENSIV™ PAS CO2 mini-board can be connected using two methods:

- **Method 1:** Connect with the XENSIV™ PAS CO2 Sensor2Go kit

The Sensor2Go kit is offered as a combination of a motherboard with a power management circuit, and a mini-board as shown in Figure 2. The Sensor2Go kit is powered via USB, and 5 V from the USB is stepped down to 3.3 V and stepped up to 12 V to ensure appropriate input voltage for the XENSIV™ PAS CO2. The Sensor2Go kit also comes with a user-friendly GUI, which can be downloaded from Infineon Toolbox.

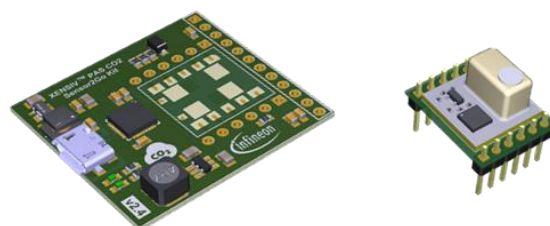


Figure 2 The connection between the Sensor2Go kit and the mini-board

XENSIV™ PAS CO2 mini-board

description and application hints

- **Method 2:** Connect with an external microcontroller separately

The mini-board can also be treated as an actual XENSIV™ PAS CO2 with a connector. Therefore, a standalone mini-board needs to be powered separately. The relevant pins of the sensor are extended to a connector pin set, as shown in Figure 3.

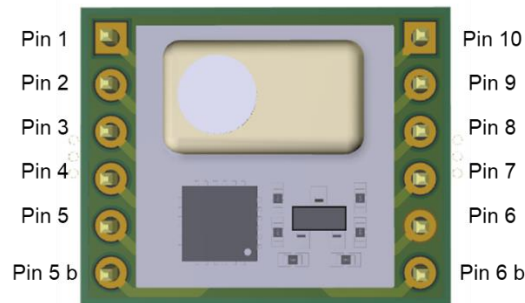


Figure 3 Top view of the XENSIV™ PAS CO2 mini-board

The relevant pin description of the XENSIV™ PAS CO2 mini-board is identical to the standalone sample, shown in the following table.

| Pin | Symbol | Type | Description |
|-----|---------|----------------------|--|
| 1 | VDD3.3 | Power supply (3.3 V) | 3.3 V digital power supply |
| 2 | RX | Input/Output | UART receiver pin |
| 3 | SCL | Input/Output | I ² C clock pin (3.3 V domain) |
| 4 | TX/SDA | Output | UART transmitter pin (3.3 V domain)/I ² C data pin (3.3 V domain) |
| 5 | PWM_DIS | Input | PWM disable input pin (3.3 V domain) |
| 5b | SWD | N/A | Do not connect |
| 6b | SWCLK | N/A | Do not connect |
| 6 | GND | Ground | Ground |
| 7 | INT | Output | Interrupt output pin (3.3 V domain) |
| 8 | PSEL | Input | Communication interface select input pin (3.3 V domain) |
| 9 | PWM | Output | PWM output pin (3.3 V domain) |
| 10 | VDD12 | Power supply (12 V) | 12 V power supply for the IR emitter |

Note: Before performing the evaluation, it is recommended to perform Forced Compensation (FC) or enable Automatic Baseline Offset Correction (ABOC).

XENSIV™ PAS CO2 mini-board

description and application hints

2 Example connection with the PSoC® 6 WiFi-BT Pioneer Kit

The mini-board can be connected to a PSoC® 6 microcontroller to investigate the application fit of the XENSIV™ PAS CO2. In this example, the mini-board has been connected with the PSoC® 6 WiFi-BT Pioneer Kit. The PSoC® 6 microcontroller contains a dual-CPU architecture, with both CPUs on a single chip. It has an ARM® Cortex®-M4 for high-performance tasks and an ARM® Cortex®-M0+ for low-power tasks. With security built in, your IoT system is protected.

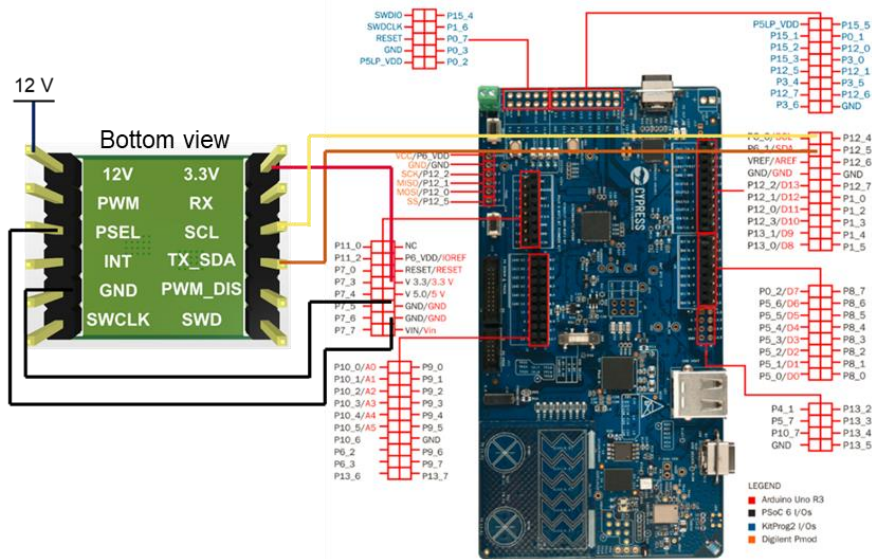


Figure 4 XENSIV™ PAS CO2 mini-board connected to the PSoC® 6 WiFi-BT Pioneer Kit

| Mini-board pin | Mini-board signal | PSoC®6 WiFi-BT Pioneer Kit signal | Comment |
|----------------|-------------------|-----------------------------------|---|
| 1 | VDD3.3 | V 3.3 | 3.3 V digital power supply |
| 2 | RX | - | Not connected |
| 3 | SCL | P6_0/SCL | I ² C clock pin (3.3 V domain) |
| 4 | TX_SDA | P6_1/SDA | I ² C data pin (3.3 V domain) |
| 5 | PWM_DIS | - | Not connected |
| 5b | SWD | - | Not connected |
| 6b | SWCLK | - | Not connected |
| 6 | GND | GND | Ground |
| 7 | INT | - | Not connected |
| 8 | PSEL | GND | Ground |
| 9 | PWM | - | Not connected |
| 10 | VDD12 | - | External 12 V power supply |

Further details on programming can be found in a separate application note, “Programming guide for XENSIV™ PAS CO2”.

XENSIV™ PAS CO2 mini-board

description and application hints



Revision history

| Document version | Date of release | Description of changes |
|------------------|-----------------|------------------------|
| V1.0 | 02.06.2021 | Creation |
| V1.1 | 26.08.2021 | Updated notes |
| | | |

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Edition 2021-08-26

Published by

Infineon Technologies AG

81726 Munich, Germany

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Email: erratum@infineon.com

Document reference

UM_2106_PL38_2106_100511

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